Application Data Sheet

Application Information

Application Type:: Regular
Subject Matter:: Utility
Suggested Group Art Unit:: N/A

CD-ROM or CD-R?:: None
Sequence submission?:: None
Computer Readable Form (CRF)?" No

Computer Readable Form (CRF)?:: No
Title:: Al/AIN JOINT MATERIAL, BASE PLATE FOR

POWER MODULE, POWER MODULE, AND MANUFACTURING METHOD OF AI/AIN JOINT MATERIAL (AS AMENDED)

Attorney Docket Number:: 09852/0205608-US0

Request for Early Publication?:: No Request for Non-Publication?:: No

Suggested Drawing Figure:: Fig. 1
Total Drawing Sheets:: 6
Small Entity?:: No

Petition included?:: No Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan
Status:: Full Capacity

Given Name:: Toshiyuki
Family Name:: Nagase
City of Residence:: Gotenba-shi

Country of Residence:: Japan

Page # 1 initial 10/03/06

Street of mailing address:: c/o Mitsubishi Materials Corporation. Central

Research Institute

Naka Research Center, 1002-14, Mukaiyama;

Naka-cho

City of mailing address:: Naka-gun

State or Province of mailing address:: Ibaraki-ken

Country of mailing address:: Japan

Applicant Authority Type:: Inventor Primary Citizenship Country:: Japan

Status" Full Capacity Given Name" Yoshivuki

Family Name:: Nagatomo Gotenba-shi City of Residence::

Country of Residence:: Japan

Street of mailing address:: c/o Mitsubishi Materials Corporation, Central

Research Institute

Naka Research Center, 1002-14, Mukaiyama:

Naka-cho

City of mailing address:: Naka-oun State or Province of mailing address:: lbaraki-ken

Country of mailing address:: Japan

Family Name::

Applicant Authority Type:: Inventor Primary Citizenship Country:: Japan

Full Capacity Status.. Given Name.. Катнакі Kuho

City of Residence:: Mishima-shi Country of Residence:: Japan

Initial 10/03/08 Page#2

Street of mailing address:: c/o Mitsubishi Materials Corporation, Central

Research Institute

Naka Research Center, 1002-14, Mukaiyama:

Naka-cho

City of mailing address:: Naka-gun
State or Province of mailing address:: Ibaraki-ken

Country of mailing address:: IDaraki-k

Country of mailing address:: Japan

Applicant Authority Type:; Inventor
Primary Citizenship Country:: Japan

Status:: Full Capacity

Family Name:: Negishi
City of Residence:: Saitama-shi
Country of Residence:: Japan

Country of Residence:: Japan

Street of mailing address:: c/o Mitsubishi Materials Corporation, Central

Research Institute

Naka Research Center, 1002-14, Mukalyama;

Naka-cho

City of mailing address:: Naka-gun
State or Province of mailing address:: Ibaraki-ken

Country of mailing address:: Japan

Correspondence Information

Correspondence Customer Number:: 07278

Representative Information

Representative Customer Number:: 07278

Page # 3 Initial 10/03/08

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2005/006618	04/04/05

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2004-110879	04/05/04	Yes
Japan	2004-221700	07/29/04	Yes

Assignee Information

Assignee name:: Mitsubishi Materials Corporation

Street of mailing address:: 5-1, Otemachi 1-chome

City of mailing address:: Chiyoda-ku

State or Province of mailing address:: Tokyo
Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 100-8117